

HVC202A

Variable Capacitance Diode for UHF/VHF tuner

REJ03G0095-0200Z
(Previous: ADE-208-405A)
Rev.2.00
Sep.23.2003

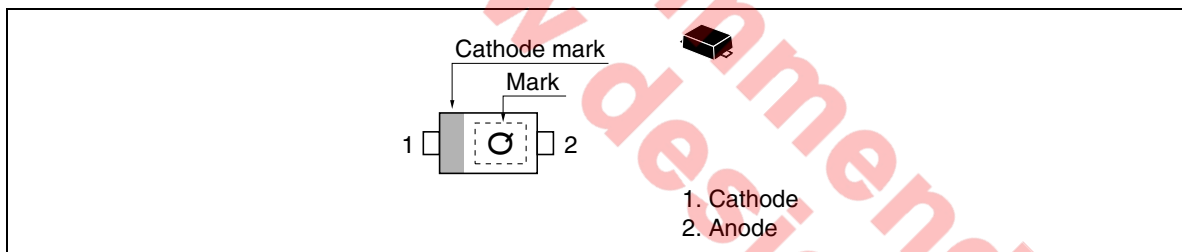
Features

- Low series resistance and good C-V linearity.
- Ultra small Flat Package (UFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVC202A	Q	UFP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V _R	34	V
Junction temperature	T _j	125	°C
Storage temperature	T _{stg}	-55 to +125	°C

Electrical Characteristics

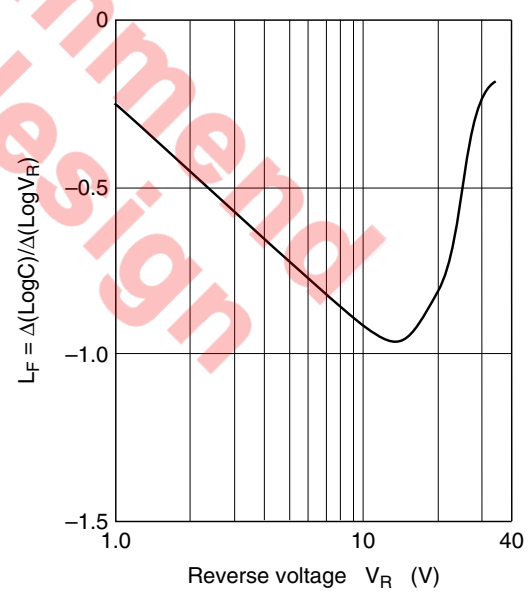
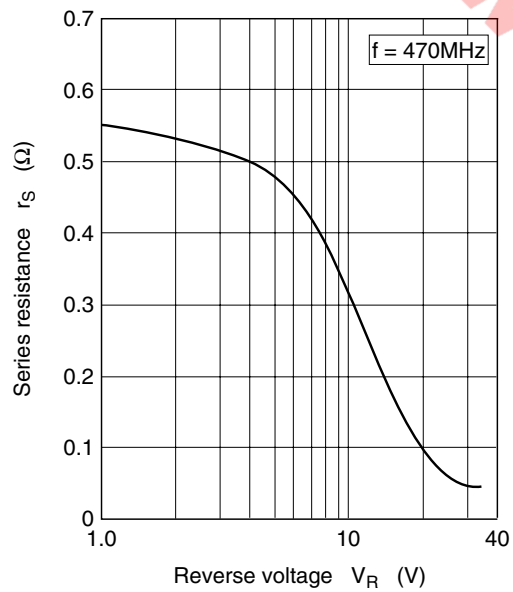
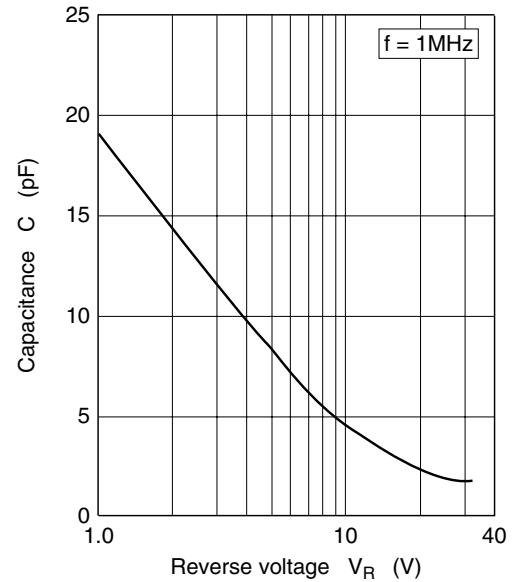
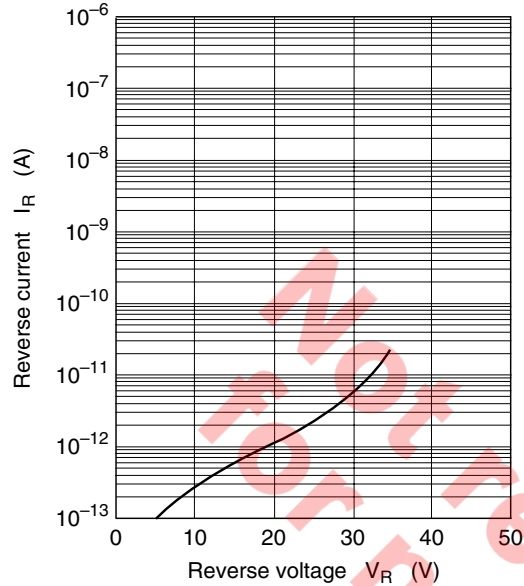
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I _{R1}	—	—	10	nA	V _R = 32 V
	I _{R2}	—	—	100		V _R = 32 V, Ta = 60°C
Capacitance	C ₂	14.11	—	16.47	pF	V _R = 2 V, f = 1 MHz
	C ₂₅	2.06	—	2.35		V _R = 25 V, f = 1 MHz
Capacitance ratio	n	6.20	—	—	—	C ₂ /C ₂₅
Series resistance	r _s	—	—	0.57	Ω	V _R = 5 V, f = 470 MHz
Matching error	ΔC/C *1	—	—	2.00	%	V _R = 2 to 25 V, f = 1 MHz

Note: 1. C.C system (Continuous Connected taping system) enable to make any 10 pcs of ΔC/C continuous in a reel , expect extention to another group.
Calculate Matching Error,

$$\Delta C/C = \frac{(C_{\max} - C_{\min})}{C_{\min}} \times 100 (\%)$$

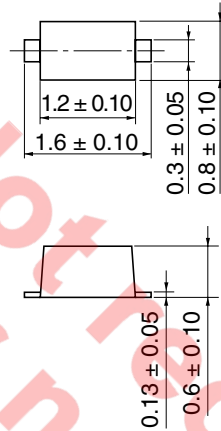
Main Characteristic



Package Dimensions

As of January, 2003

Unit: mm



Package Code	UFP
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.0016 g

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